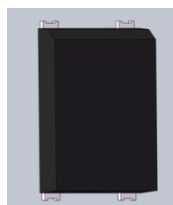


Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F (V)	I _R (μA)
1,000	3	1.0	5

Description and Applications

Suitable for AC to DC bridge full wave rectification for SMPS, LED lighting, adapters, battery chargers, home appliances, office equipment, and telecommunication applications.



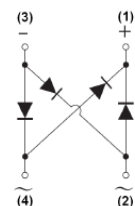
Top View

Features and Benefits

- Glass Passivated Die Construction
- Miniature Package Saves Space on PC Boards
- Low Leakage Current
- Ideal for SMT Manufacturing
- Low Forward Voltage Drop
- Surge Overload Rating to 110A Peak
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Mechanical Data

- Case: DBF
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: As Marked on Body
- Weight: 0.214 grams (Approximate)



Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DBF310-13	Commercial	DBF	3,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



DBF310 = Product Type Marking Code
 ☐ = Manufacturers' Code Marking
 YM = Date Code Marking
 Y = Last Digit of Year (ex: 7 = 2017)
 M = See Month/Code Table Below
 D = Day 1~9 =1~9; Day 10~31= A~V

Month Code	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	1,000	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current (Note 5) @ T _C = +120°C	I _O	3.0	A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	110	A
I ² t Rating for Fusing (1ms < t < 8.3ms)	I ² t	50.2	A ² S

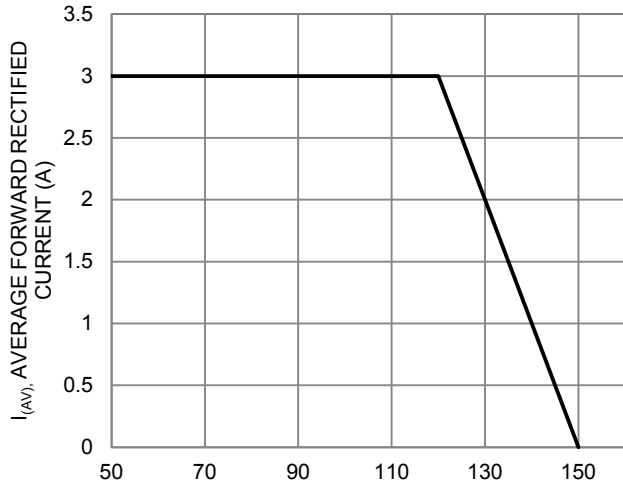
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	R _{θJA}	15	°C/W
Typical Thermal Resistance, Junction to Case (Per Element)	R _{θJC}	5	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

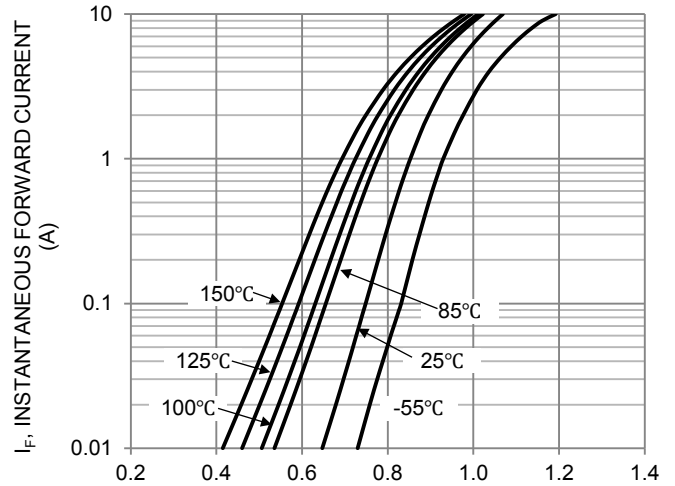
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	1,000	—	—	V	I _R = 5μA
Forward Voltage (Per Element)	V _F	—	0.88 0.93	0.95 1.0	V	I _F = 1.5A, T _A = +25°C I _F = 3A, T _A = +25°C
Leakage Current (Note 7) (Per Element)	I _R	—	0.07 25	5 500	μA	V _R = 1,000V, T _A = +25°C V _R = 1,000V, T _A = +125°C
Total Capacitance (Per Element)	C _T	—	35	—	pF	V _R = 4V, f = 1.0MHz

Notes: 5. Device mounted on glass epoxy PC board with 1.3mm² solder pad.
 6. Device mounted on glass epoxy substrate with 1oz/ft², 15mmx15mm copper pad per pin.
 7. Short duration pulse test used to minimize self-heating effect.



T_C , CASE TEMPERATURE (°C)
Figure 1. Output Current Derating Curve



V_F , INSTANTANEOUS FORWARD VOLTAGE (V)
Figure 2. Typical Forward Characteristics (Per Leg)

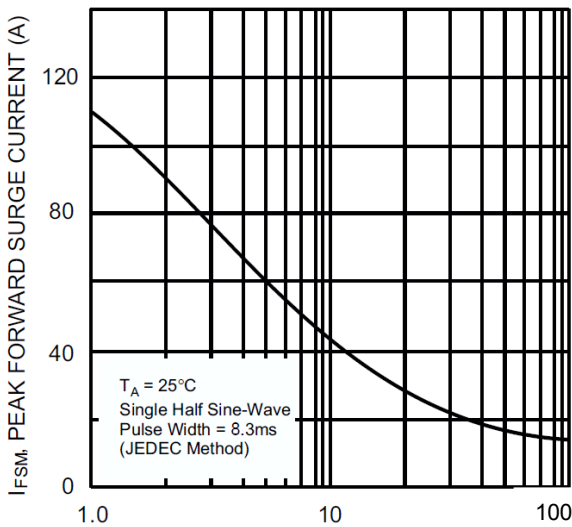


Figure 3. Maximum Peak Forward Surge Current (Per Leg)

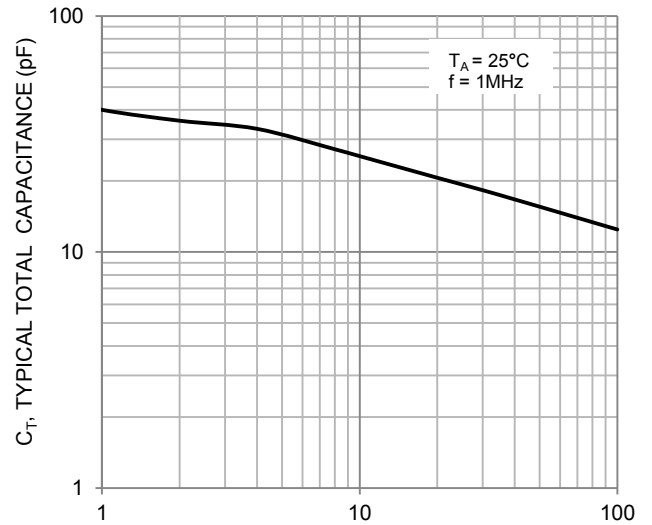


Figure 4. Typical Total Capacitance (Per Leg)

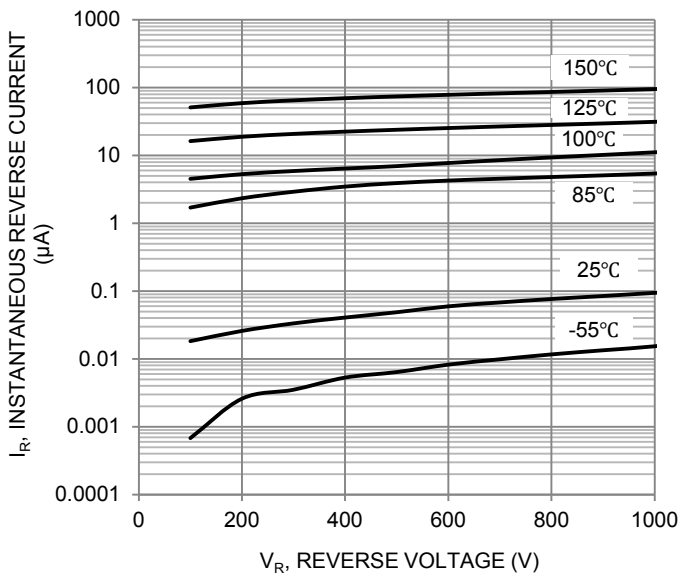
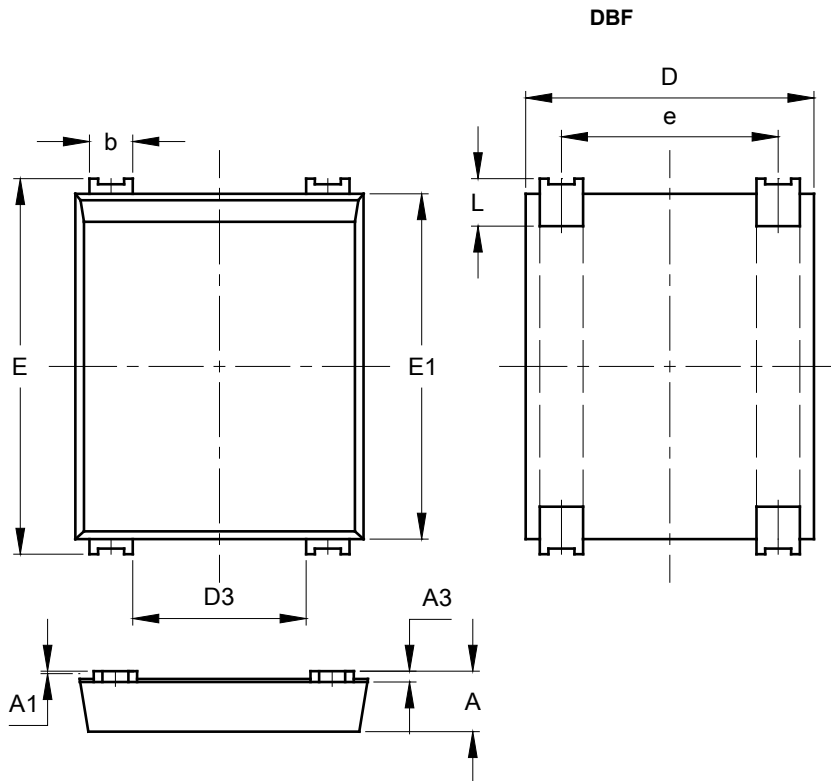


Figure 5. Typical Reverse Characteristics

Package Outline Dimensions

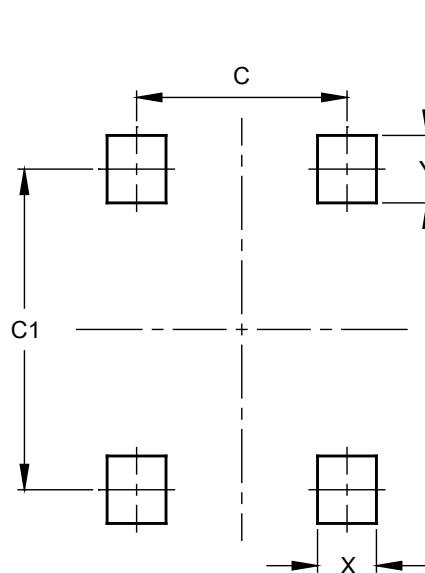
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dim	Min	Max
A	1.30	1.50
A1	0.04	0.12
A3	0.15	0.35
b	0.80	1.20
D	6.45	6.85
D3	3.80	4.20
E	8.50	8.90
E1	7.50	8.20
e	4.80	5.20
L	0.50	1.50
All dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	5.00
C1	7.60
X	1.40
Y	1.60

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